Unit in mm

Preliminary

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSII)

SSM6K08FU

High Speed Switching Applications

• Small package

• Low on resistance: $R_{on} = 105 \text{ m}\Omega \text{ (max) (@VGS} = 4 \text{ V)}$

 $R_{on} = 140 \text{ m}\Omega \text{ (max) (@VGS} = 2.5 \text{ V)}$

• High-speed switching: ton = 16 ns (typ.)

 $t_{off} = 15 \text{ ns (typ.)}$

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V _{DS}	20	V	
Gate-Source voltage		V _{GSS}	±12	V	
Drain current	DC	I _D	1.6	А	
	Pulse	I _{DP}	3.2		
Drain power dissipation		P _D (Note1)	300	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

1, 2, 5, 6 : DRAIN
3 : GATE
4 : SOURCE

US6

JEDEC —
EIAJ —
TOSHIBA 2-2J1D

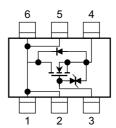
Note1: Mounted on FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ t}, \text{ Cu Pad: } 0.32 \text{ mm}^2 \times 6)$ Figure 1.

Marking

6 5 4 KDC

Equivalent Circuit (top view)



Handling Precaution

When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

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Electrical Characteristics (Ta = 25°C)

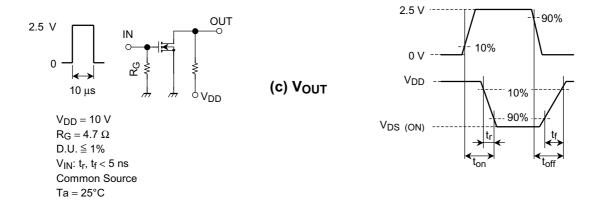
Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0$	_	_	±1	μА	
Drain-Source breakdown voltage		V (BR) DSS	$I_D = 1 \text{ mA}, V_{GS} = 0$	20	_	_	V	
		V (BR) DSX	$I_D = 1 \text{ mA}, V_{GS} = -12 \text{ V}$	12	_	_	V	
Drain cut-off curre	ent	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0	_	_	1	μА	
Gate threshold vo	oltage	V _{th}	$V_{DS} = 3 \text{ V}, I_D = 0.1 \text{ mA}$	0.5	_	1.2	V	
Forward transfer	admittance	Y _{fs}	$V_{DS} = 3 \text{ V}, I_D = 0.8 \text{ A}$ (Note:	2.0	_	_	S	
Drain-Source ON resistance		R _{DS} (ON)	$I_D = 0.8 \text{ A}, V_{GS} = 4 \text{ V}$ (Note:	2) —	77	105	mΩ	
			$I_D = 0.8 \text{ A}, V_{GS} = 2.5 \text{ V}$ (Note:	2) —	100	140		
			I _D = 0.8 A, V _{GS} = 2.0 V (Note:	2) —	125	210		
Input capacitance)	C_{iss} $V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		_	306	_	pF	
Reverse transfer capacitance C		C _{rss}	V _{DS} = 10 V, V _{GS} = 0, f = 1 MHz	_	44	_	pF	
Output capacitance		C _{oss}	V _{DS} = 10 V, V _{GS} = 0, f = 1 MHz	_	74	_	pF	
Switching time	Turn-on time	t _{on}	$V_{DD} = 10 \text{ V}, I_D = 0.8 \text{ A},$	_	16	_	ns	
	Turn-off time	t _{off}	$V_{GS} = 0~2.5 \text{ V}, R_G = 4.7 \Omega$	_	15	_		

Note2: Pulse test

Switching Time Test Circuit



(b) V_{IN}

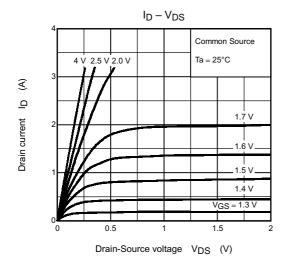


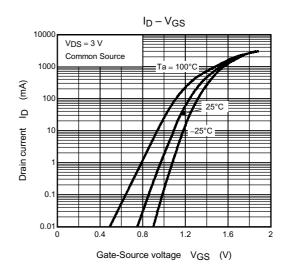
Precaution

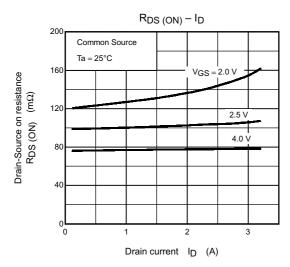
 V_{th} can be expressed as voltage between gate and source when low operating current value is $I_D = 100 \,\mu\text{A}$ for this product. For normal switching operation, V_{GS} (on) requires higher voltage than V_{th} and V_{GS} (off) requires lower voltage than V_{th} .

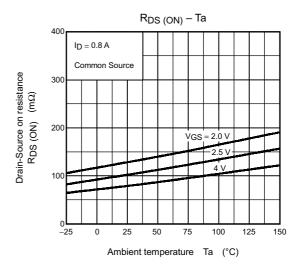
(Relationship can be established as follows: $V_{GS\;(off)}$ < V_{th} < $V_{GS\;(on)}$)

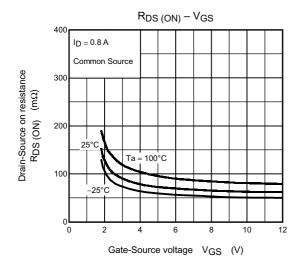
Please take this into consideration for using the device. VGS recommended voltage of 2.5 V or higher to turn on this product.

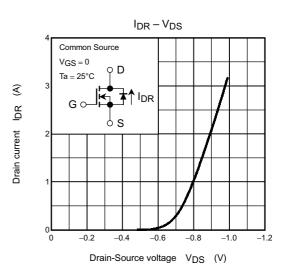


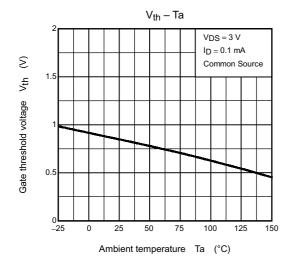


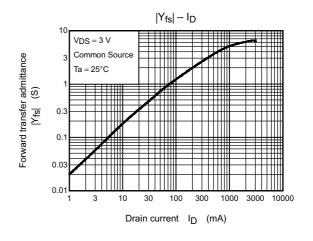


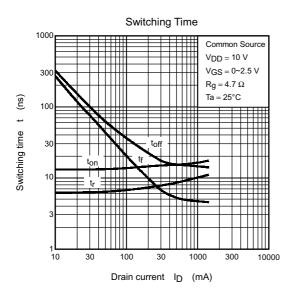


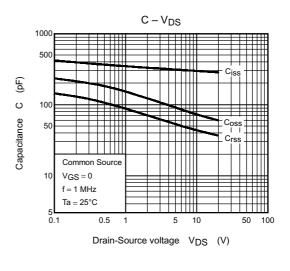


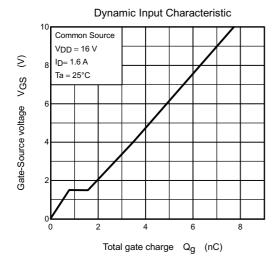


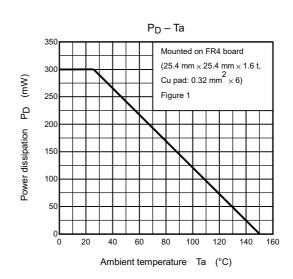


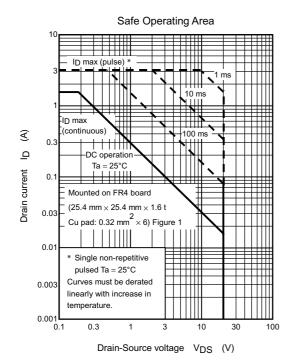


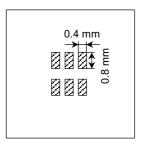












25.4 mm \times 25.4 mm \times 1.6 t, Cu Pad: 0.32 mm² \times 6

Figure 1